

# **Inductors for Power Circuits**

# Wound/STD • magnetic shielded

# **VLF** series

Type: VLF252010MT (2.5x2.0x1.0 mm)

VLF252012MT (2.5x2.0x1.2 mm)
VLF252015MT (2.5x2.0x1.5 mm)
VLF302510MT (3.0x2.5x1.0 mm)
VLF302512MT (3.0x2.5x1.2 mm)
VLF302515MT (3.0x2.5x1.5 mm)
VLF403210MT (4.0x3.2x1.0 mm)
VLF403212MT (4.0x3.2x1.2 mm)
VLF403215MT (4.0x3.2x1.5 mm)
VLF504010MT (5.0x4.0x1.0 mm)
VLF504012MT (5.0x4.0x1.2 mm)
VLF504015MT (5.0x4.0x1.5 mm)

Issue date: October 2012

<sup>•</sup> All specifications are subject to change without notice.

<sup>•</sup> Conformity to RoHS Directive: This means that, in conformity with EU Directive 2002/95/EC, lead, cadmium, mercury, hexavalent chromium, and specific bromine-based flame retardants, PBB and PBDE, have not been used, except for exempted applications.

# Inductors for Power Circuits Wound/STD • Magnetic Shielded

**Conformity to RoHS Directive** 

#### VLF Series VLF252010MT

With the VLF252010MT Series, a DC to DC converter with topclass voltage conversion efficiency for similar size products was achieved by optimizing the magnetic material and configuration. These products are optimal for use as choke coils in switching power supplies such as those in mobile devices requiring spacesaving design.

#### **FEATURES**

Miniature size

Mount area: 2.5×2.0mm

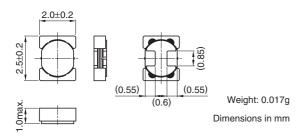
Low profile: 1.0mm max. height

- Generic use for portable DC to DC converter line.
- High magnetic shield construction should actualize high resolution for EMC protection.
- The products contain no lead and also support lead-free soldering.
- The products is halogen-free.
- · It is a product conforming to RoHS directive.

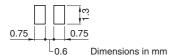
#### **APPLICATIONS**

Smartphones, cellular phones, DSCs, DVCs, HDDs, LCD displays, compact power supply modules, etc.

#### **SHAPES AND DIMENSIONS**



#### **RECOMMENDED PC BOARD PATTERN**



#### CIRCUIT DIAGRAM





#### PRODUCT IDENTIFICATION

VLF	252010M	Τ -	- 1R0	Ν
(1)	(2)	(3)	(4)	(5)

- (1) Series name
- (2) Dimensions L×W×H mm max.

#### (3) Packaging style

T	Taping (Embossed carrier tape)
(4) Inductance value	
1R0	1.0μΗ
100	10μΗ
(5) Inductance tolerance	
М	±20%

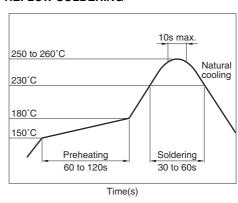
#### **PACKAGING STYLE AND QUANTITIES**

Packaging style	Quantity
Taping	2000 pieces/reel

±30%

#### HANDLING AND PRECAUTIONS

- Before soldering, be sure to preheat components.
   The preheating temperature should be set so that the temperature difference between the solder temperature and product temperature does not exceed 150°C.
- When hand soldering, apply the soldering iron to the printed circuit board only. Temperature of the iron tip should not exceed 350°C. Soldering time should not exceed 3 seconds.



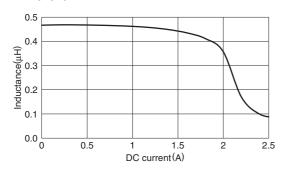
- Conformity to RoHS Directive: This means that, in conformity with EU Directive 2002/95/EC, lead, cadmium, mercury, hexavalent chromium, and specific bromine-based flame retardants, PBB and PBDE, have not been used, except for exempted applications.
- Please contact our Sales office when your application is considered the following:
   The device's failure or malfunction may directly endanger human life (e.g. application for automobile/aircraft/medical/nuclear power devices, etc.)



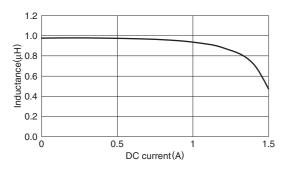
				DC resis	$stance(\Omega)$	Rated cu	ırrent*(A)	
Part No.	Inductance (µH)	Inductance tolerance(%)	Test frequency (MHz)	max.	typ.	Based o	n inductance dc1	Based on temperature rise Idc2
						max.	typ.	typ.
VLF252010MT-R47N	0.47	±30	1.0	0.029	0.024	1.84	2.04	3.35
VLF252010MT-R68N	0.68	±30	1.0	0.043	0.036	1.53	1.70	2.70
VLF252010MT-1R0N	1.0	±30	1.0	0.059	0.049	1.27	1.41	2.25
VLF252010MT-1R5N	1.5	±30	1.0	0.090	0.075	0.99	1.10	1.83
VLF252010MT-2R2M	2.2	±20	1.0	0.12	0.097	0.83	0.92	1.47
VLF252010MT-3R3M	3.3	±20	1.0	0.19	0.16	0.68	0.75	1.15
VLF252010MT-4R7M	4.7	±20	1.0	0.30	0.25	0.57	0.64	0.95
VLF252010MT-6R8M	6.8	±20	1.0	0.36	0.30	0.47	0.53	0.85
VLF252010MT-100M	10.0	±20	1.0	0.59	0.49	0.39	0.44	0.66
VLF252010MT-150M	15.0	±20	1.0	0.87	0.73	0.31	0.34	0.53
VLF252010MT-220M	22.0	±20	1.0	1.26	1.05	0.26	0.29	0.45

<sup>\*</sup> Rated current: Value obtained when current flows and the temperature has risen to 40°C or when DC current flows and the nominal value of inductance has fallen by 30%, whichever is smaller.

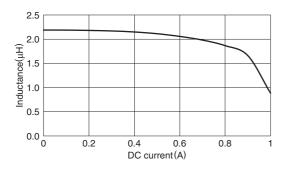
# TYPICAL ELECTRICAL CHARACTERISTICS INDUCTANCE vs. DC SUPERPOSITION CHARACTERISTICS VLF252010MT-R47N



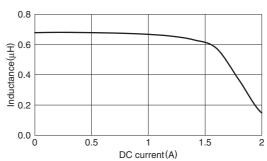
#### VLF252010MT-1R0N



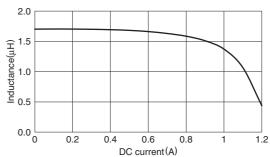
#### VLF252010MT-2R2M



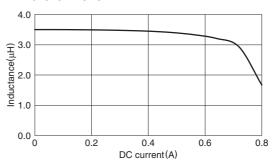
#### VLF252010MT-R68N



# VLF252010MT-1R5N



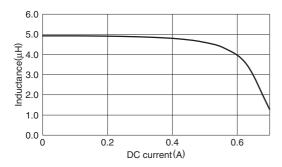
### VLF252010MT-3R3M



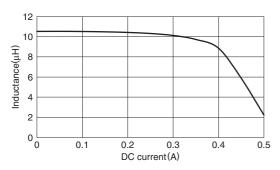
<sup>•</sup> Operating temperature range: -40 to +105°C (Including self-temperature rise)

<sup>•</sup> All specifications are subject to change without notice.

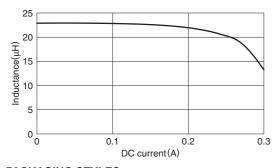
# TYPICAL ELECTRICAL CHARACTERISTICS INDUCTANCE vs. DC SUPERPOSITION CHARACTERISTICS VLF252010MT-4R7M



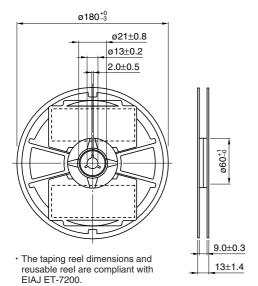
#### VLF252010MT-100M



#### VLF252010MT-220M

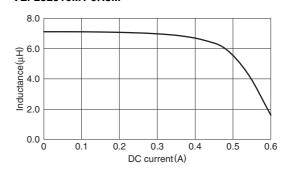


# PACKAGING STYLES REEL DIMENSIONS

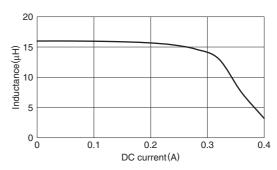


Dimensions in mm

#### VLF252010MT-6R8M



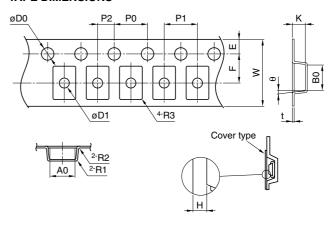
#### VLF252010MT-150M



#### **TEST CIRCUIT**



2: DC constant current source



				Dimensions in mm
A0	B0	W	F	Е
2.3typ.	2.8typ.	8.00±0.2	3.50±0.1	1.75±0.1
P1	P2	Н	P0	øD0
4.00±0.1	2.00±0.05	0.05 to 0.35	4.0±0.1	1.5+0.1/-0
K	øD1	t	R1 to R3	θ
1.15±0.1	1.2±0.2	0.25±0.05	0.3max.	5° typ.

# **会TDK**

# Inductors for Power Circuits Wound/STD • Magnetic Shielded

**Conformity to RoHS Directive** 

#### VLF-MT Series VLF252012MT

With the VLF252012MT Series, a DC to DC converter with topclass voltage conversion efficiency for similar size products was achieved by optimizing the magnetic material and configuration. These products are optimal for use as choke coils in switching power supplies such as those in mobile devices requiring spacesaving design.

#### **FEATURES**

Miniature size

Mount area: 2.5×2.0mm

Low profile: 1.2mm max. height

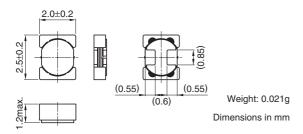
• Generic use for portable DC to DC converter line.

- High magnetic shield construction should actualize high resolution for EMC protection.
- The products contain no lead and also support lead-free soldering.
- The products is halogen-free.
- · It is a product conforming to RoHS directive.

#### **APPLICATIONS**

Smartphones, cellular phones, DSCs, DVCs, HDDs, LCD displays, compact power supply modules, etc.

#### **SHAPES AND DIMENSIONS**



#### **RECOMMENDED PC BOARD PATTERN**



#### CIRCUIT DIAGRAM





#### PRODUCT IDENTIFICATION

VLF	252012M	Т	- 1R0	Ν
(1)	(2)	(3)	(4)	(5)

- (1) Series name
- (2) Dimensions L×W×H mm max.

#### (3) Packaging style

T	(Embossed carrier tape)
(4) Inductance value	
1R0	1.0μΗ
100	10μΗ
(5) Inductance tolerance	
M	+20%

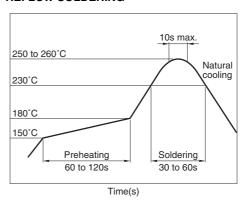
#### **PACKAGING STYLE AND QUANTITIES**

Packaging style	Quantity
Taping	2000 pieces/reel

±30%

#### HANDLING AND PRECAUTIONS

- Before soldering, be sure to preheat components.
   The preheating temperature should be set so that the temperature difference between the solder temperature and product temperature does not exceed 150°C.
- When hand soldering, apply the soldering iron to the printed circuit board only. Temperature of the iron tip should not exceed 350°C. Soldering time should not exceed 3 seconds.

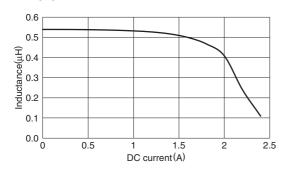


- Conformity to RoHS Directive: This means that, in conformity with EU Directive 2002/95/EC, lead, cadmium, mercury, hexavalent chromium, and specific bromine-based flame retardants, PBB and PBDE, have not been used, except for exempted applications.
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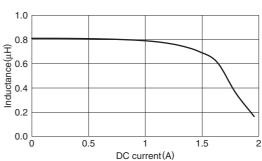
				DC resis	$stance(\Omega)$	Rated cu	ırrent*(A)	
Part No.	Inductance (µH)	Inductance tolerance(%)	Test frequency (MHz)	max.	typ.	Based o	n inductance dc1	Based on temperature rise Idc2
						max.	typ.	typ.
VLF252012MT-R47N	0.47	±30	1.0	0.029	0.024	1.89	2.10	3.45
VLF252012MT-R68N	0.68	±30	1.0	0.038	0.032	1.55	1.72	3.04
VLF252012MT-1R0N	1.0	±30	1.0	0.052	0.043	1.30	1.44	2.47
VLF252012MT-1R5N	1.5	±30	1.0	0.069	0.057	1.10	1.22	2.17
VLF252012MT-2R2M	2.2	±20	1.0	0.10	0.085	0.94	1.04	1.67
VLF252012MT-3R3M	3.3	±20	1.0	0.15	0.13	0.70	0.78	1.39
VLF252012MT-4R7M	4.7	±20	1.0	0.22	0.18	0.62	0.69	1.09
VLF252012MT-6R8M	6.8	±20	1.0	0.34	0.28	0.50	0.56	0.89
VLF252012MT-100M	10.0	±20	1.0	0.41	0.34	0.41	0.46	0.78
VLF252012MT-150M	15.0	±20	1.0	0.68	0.57	0.33	0.37	0.63
VLF252012MT-220M	22.0	±20	1.0	1.00	0.83	0.28	0.31	0.46

<sup>\*</sup> Rated current: Value obtained when current flows and the temperature has risen to 40°C or when DC current flows and the nominal value of inductance has fallen by 30%, whichever is smaller.

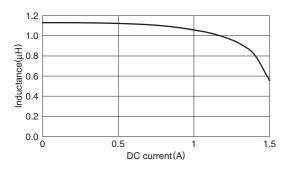
# TYPICAL ELECTRICAL CHARACTERISTICS INDUCTANCE vs. DC SUPERPOSITION CHARACTERISTICS VLF252012MT-R47N



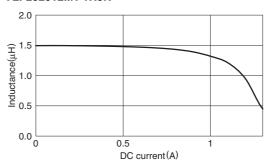
# VLF252012MT-R68N



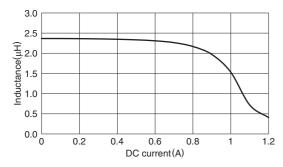
#### VLF252012MT-1R0N



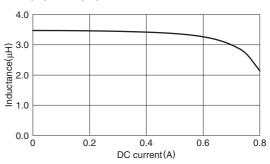
## VLF252012MT-1R5N



#### VLF252012MT-2R2M



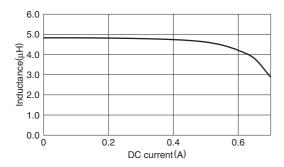
#### VLF252012MT-3R3M



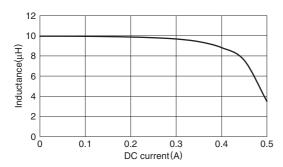
<sup>•</sup> Operating temperature range: -40 to +105°C (Including self-temperature rise)

<sup>•</sup> All specifications are subject to change without notice.

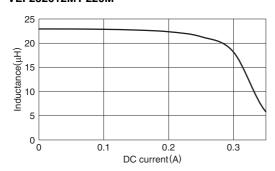
# TYPICAL ELECTRICAL CHARACTERISTICS INDUCTANCE vs. DC SUPERPOSITION CHARACTERISTICS VLF252012MT-4R7M



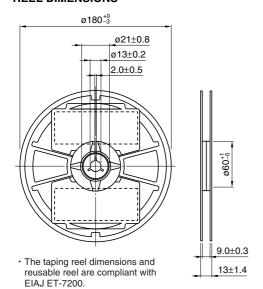
#### VLF252012MT-100M



#### VLF252012MT-220M

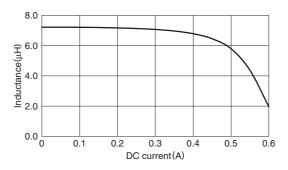


# PACKAGING STYLES REEL DIMENSIONS

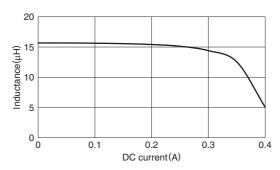


# Dimensions in mm

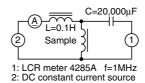
#### VLF252012MT-6R8M

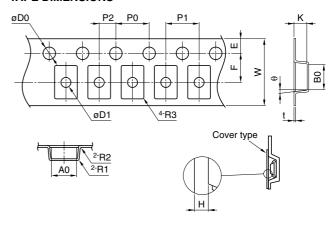


#### VLF252012MT-150M



#### **TEST CIRCUIT**





				Dimensions in mm
A0	B0	W	F	E
2.3typ.	2.8typ.	8.00±0.2	3.50±0.1	1.75±0.1
P1	P2	Н	P0	øD0
4.00±0.1	2.00±0.05	0.05 to 0.35	4.0±0.1	1.5+0.1/-0
K	øD1	t	R1 to R3	θ
1.35±0.1	1.2±0.2	0.25±0.05	0.3max.	5° typ.

# Inductors for Power Circuits Wound/STD • Magnetic Shielded

**Conformity to RoHS Directive** 

#### VLF Series VLF252015MT

With the VLF252015MT Series, a DC to DC converter with topclass voltage conversion efficiency for similar size products was achieved by optimizing the magnetic material and configuration. These products are optimal for use as choke coils in switching power supplies such as those in mobile devices requiring spacesaving design.

#### **FEATURES**

Miniature size

Mount area: 2.5×2.0mm

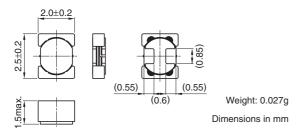
Low profile: 1.5mm max. height

- Generic use for portable DC to DC converter line.
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- The products is halogen-free.
- · It is a product conforming to RoHS directive.

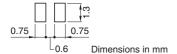
#### **APPLICATIONS**

Smartphones, cellular phones, DSCs, DVCs, HDDs, LCD displays, compact power supply modules, etc.

#### **SHAPES AND DIMENSIONS**



#### **RECOMMENDED PC BOARD PATTERN**



#### CIRCUIT DIAGRAM





#### PRODUCT IDENTIFICATION

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(1)	(2)	(3)	(4)	(5)

- (1) Series name
- (2) Dimensions L×W×H mm max.

#### (3) Packaging style

T	raping (Embossed carrier tape)
(4) Inductance value	
1R0	1.0μΗ
100	10μΗ
(5) Inductance tolera	nce

#### M

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DACKACING STVI E AND OHANTITIES	

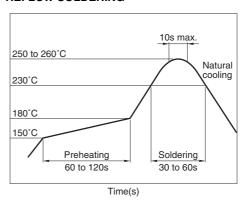
±20%

#### PACKAGING STYLE AND QUANTITIES

Packaging style	Quantity
Taping	2000 pieces/reel

#### HANDLING AND PRECAUTIONS

- Before soldering, be sure to preheat components.
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- When hand soldering, apply the soldering iron to the printed circuit board only. Temperature of the iron tip should not exceed 350°C. Soldering time should not exceed 3 seconds.



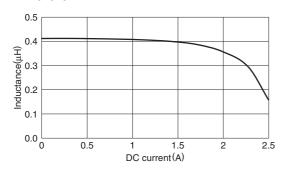
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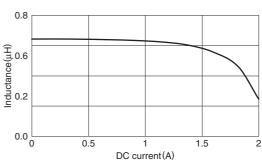
				DC resis	$stance(\Omega)$	Rated cu	urrent*(A)	
Part No.	Inductance (µH)	Inductance tolerance(%)	Test frequency (MHz)	max.	typ.	Based o	n inductance ldc1	Based on temperature rise Idc2
						max.	typ.	typ.
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VLF252015MT-R68N	0.68	±30	1.0	0.023	0.019	1.54	1.71	3.38
VLF252015MT-1R0N	1.0	±30	1.0	0.030	0.025	1.34	1.49	3.13
VLF252015MT-1R5N	1.5	±30	1.0	0.039	0.033	1.02	1.13	2.58
VLF252015MT-2R2M	2.2	±20	1.0	0.068	0.056	0.87	0.97	2.10
VLF252015MT-3R3M	3.3	±20	1.0	0.096	0.080	0.71	0.79	1.70
VLF252015MT-4R7M	4.7	±20	1.0	0.12	0.10	0.59	0.66	1.45
VLF252015MT-6R8M	6.8	±20	1.0	0.19	0.16	0.52	0.57	1.14
VLF252015MT-100M	10.0	±20	1.0	0.28	0.24	0.42	0.47	0.94
VLF252015MT-150M	15.0	±20	1.0	0.45	0.37	0.34	0.37	0.77
VLF252015MT-220M	22.0	±20	1.0	0.73	0.61	0.28	0.31	0.58

<sup>\*</sup> Rated current: Value obtained when current flows and the temperature has risen to 40°C or when DC current flows and the nominal value of inductance has fallen by 30%, whichever is smaller.

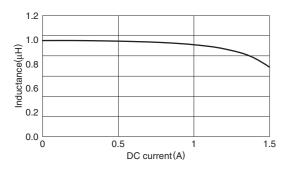
# TYPICAL ELECTRICAL CHARACTERISTICS INDUCTANCE vs. DC SUPERPOSITION CHARACTERISTICS VLF252015MT-R47N



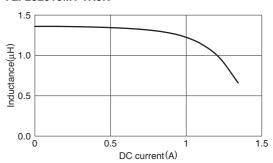
### VLF252015MT-R68N



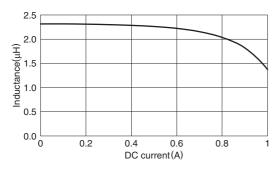
#### VLF252015MT-1R0N



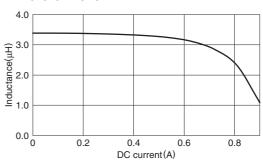
## VLF252015MT-1R5N



#### VLF252015MT-2R2M



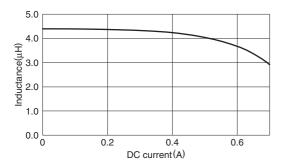
#### VLF252015MT-3R3M



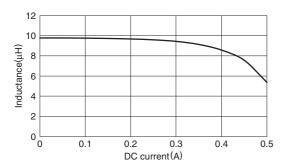
<sup>•</sup> Operating temperature range: -40 to +105°C (Including self-temperature rise)

<sup>•</sup> All specifications are subject to change without notice.

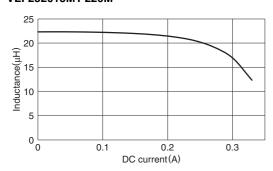
# TYPICAL ELECTRICAL CHARACTERISTICS INDUCTANCE vs. DC SUPERPOSITION CHARACTERISTICS VLF252015MT-4R7M



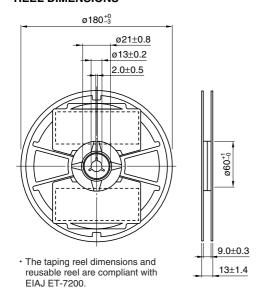
#### VLF252015MT-100M



#### VLF252015MT-220M

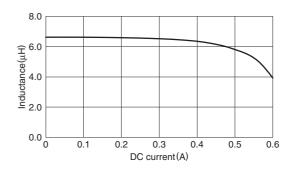


# PACKAGING STYLES REEL DIMENSIONS

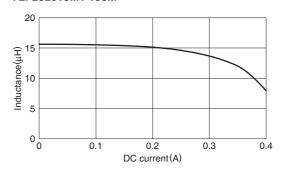


# Dimensions in mm

#### VLF252015MT-6R8M



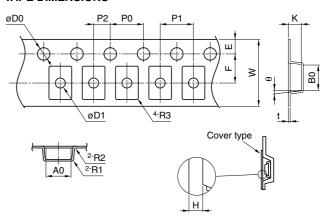
#### VLF252015MT-150M



#### **TEST CIRCUIT**



#### 2: DC constant current source



				Dimensions in mm
A0	B0	W	F	E
2.3typ.	2.8typ.	8.00±0.2	3.50±0.1	1.75±0.1
P1	P2	Н	P0	øD0
4.00±0.1	2.00±0.05	0.05 to 0.35	4.0±0.1	1.5+0.1/-0
K	øD1	t	R1 to R3	θ
1.65±0.1	1.2±0.2	0.25±0.05	0.3max.	5° typ.

# Inductors for Power Circuits Wound/STD • Magnetic Shielded

## **Conformity to RoHS Directive**

#### VLF Series VLF302510MT

With the VLF302510MT Series, a DC to DC converter with topclass voltage conversion efficiency for similar size products was achieved by optimizing the magnetic material and configuration. These products are optimal for use as choke coils in switching power supplies such as those in mobile devices requiring spacesaving design.

#### **FEATURES**

Miniature size

Mount area: 3.0×2.5mm

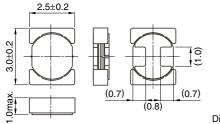
Low profile: 1.0mm max. height

- Generic use for portable DC to DC converter line.
- High magnetic shield construction should actualize high resolution for EMC protection.
- The products contain no lead and also support lead-free soldering.
- · The products is halogen-free.
- · It is a product conforming to RoHS directive.

#### **APPLICATIONS**

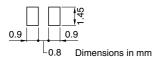
Smartphones, cellular phones, DSCs, DVCs, HDDs, LCD displays, compact power supply modules, etc.

#### **SHAPES AND DIMENSIONS**



Weight: 0.026g
Dimensions in mm

### RECOMMENDED PC BOARD PATTERN



#### CIRCUIT DIAGRAM





#### PRODUCT IDENTIFICATION

VLF	302510M	Т -	1R0	Ν
(1)	(2)	(3)	(4)	(5)

- (1) Series name
- (2) Dimensions L×W×H mm max.

#### (3) Packaging style

<u>T</u>	Taping (Embossed carrier tape)
(4) Inductance value	
1R0	1.0μΗ
100	10μΗ
(5) Inductance tolerance	
M	±20%

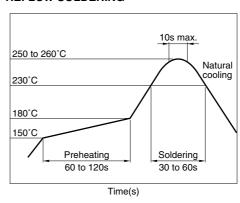
±30%

#### **PACKAGING STYLE AND QUANTITIES**

Packaging style	Quantity
Taping	2000 pieces/reel

#### HANDLING AND PRECAUTIONS

- Before soldering, be sure to preheat components.
   The preheating temperature should be set so that the temperature difference between the solder temperature and product temperature does not exceed 150°C.
- When hand soldering, apply the soldering iron to the printed circuit board only. Temperature of the iron tip should not exceed 350°C. Soldering time should not exceed 3 seconds.

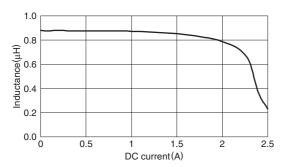


- Conformity to RoHS Directive: This means that, in conformity with EU Directive 2002/95/EC, lead, cadmium, mercury, hexavalent chromium, and specific bromine-based flame retardants, PBB and PBDE, have not been used, except for exempted applications.
- Please contact our Sales office when your application is considered the following:
   The device's failure or malfunction may directly endanger human life (e.g. application for automobile/aircraft/medical/nuclear power devices, etc.)

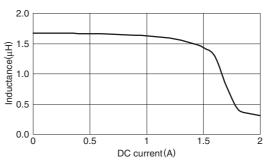
-				DC resis	$stance(\Omega)$	Rated cu	ırrent*(A)	
Part No.	Inductance (µH)	Inductance tolerance(%)	Test frequency (MHz)	max.	typ.	Based or change I	n inductance dc1	Based on temperature rise Idc2
						max.	typ.	typ.
VLF302510MT-1R0N	1.0	±30	1.0	0.040	0.033	2.00	2.22	2.13
VLF302510MT-1R5N	1.5	±30	1.0	0.066	0.055	1.49	1.65	1.65
VLF302510MT-2R2M	2.2	±20	1.0	0.084	0.070	1.23	1.37	1.50
VLF302510MT-3R3M	3.3	±20	1.0	0.126	0.105	1.09	1.21	1.20
VLF302510MT-4R7M	4.7	±20	1.0	0.168	0.140	0.86	0.95	1.08
VLF302510MT-6R8M	6.8	±20	1.0	0.258	0.215	0.73	0.81	0.84
VLF302510MT-100M	10	±20	1.0	0.372	0.310	0.59	0.65	0.73
VLF302510MT-150M	15	±20	1.0	0.600	0.500	0.47	0.52	0.55
VLF302510MT-220M	22	±20	1.0	0.876	0.730	0.38	0.42	0.45

<sup>\*</sup> Rated current: Value obtained when current flows and the temperature has risen to 40°C or when DC current flows and the nominal value of inductance has fallen by 30%, whichever is smaller.

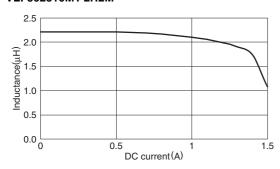
# TYPICAL ELECTRICAL CHARACTERISTICS INDUCTANCE vs. DC SUPERPOSITION CHARACTERISTICS VLF302510MT-1R0N



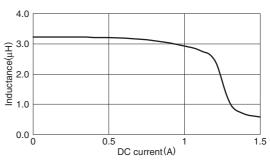
# VLF302510MT-1R5N



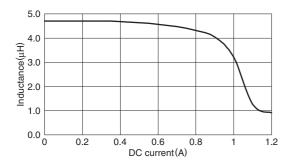
### VLF302510MT-2R2M



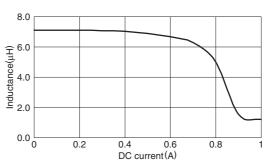
#### VLF302510MT-3R3M



#### VLF302510MT-4R7M



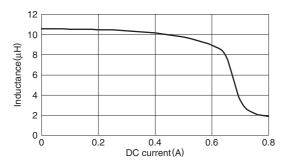
#### VLF302510MT-6R8M



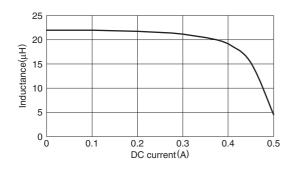
<sup>•</sup> Operating temperature range: -40 to +105°C (Including self-temperature rise)

<sup>•</sup> All specifications are subject to change without notice.

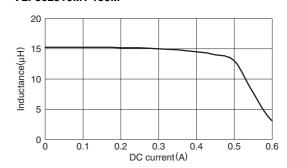
# TYPICAL ELECTRICAL CHARACTERISTICS INDUCTANCE vs. DC SUPERPOSITION CHARACTERISTICS VLF302510MT-100M



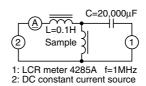
#### VLF302510MT-220M



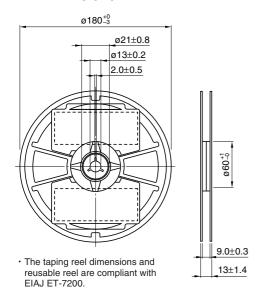
#### VLF302510MT-150M



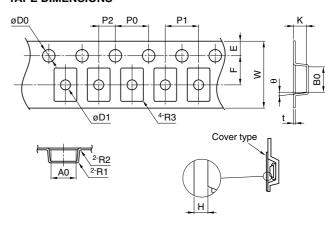
#### **TEST CIRCUIT**



# PACKAGING STYLES REEL DIMENSIONS



Dimensions in mm



				Dimensions in mm
A0	В0	W	F	Е
2.8typ.	3.3typ.	8.00± 0.2	3.50± 0.1	1.75± 0.1
P1	P2	Н	P0	øD0
4.00± 0.1	2.00±0.05	0.05 to 0.35	4.0±0.1	1.5+0.1/-0
K	øD1	t	R1 to R3	θ
1.15±0.1	1.2±0.2	0.25±0.05	0.3max.	5° typ.

<sup>•</sup> All specifications are subject to change without notice.

# Inductors for Power Circuits Wound/STD • Magnetic Shielded

## **Conformity to RoHS Directive**

### VLF Series VLF302512MT

With the VLF302512MT Series, a DC to DC converter with topclass voltage conversion efficiency for similar size products was achieved by optimizing the magnetic material and configuration. These products are optimal for use as choke coils in switching power supplies such as those in mobile devices requiring spacesaving design.

#### **FEATURES**

Miniature size

Mount area: 3.0×2.5mm

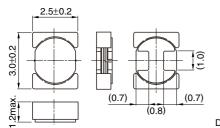
Low profile: 1.2mm max. height

- Generic use for portable DC to DC converter line.
- High magnetic shield construction should actualize high resolution for EMC protection.
- The products contain no lead and also support lead-free soldering.
- · The products is halogen-free.
- · It is a product conforming to RoHS directive.

#### **APPLICATIONS**

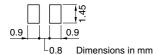
Smartphones, cellular phones, DSCs, DVCs, HDDs, LCD displays, compact power supply modules, etc.

#### **SHAPES AND DIMENSIONS**



Weight: 0.033g

#### RECOMMENDED PC BOARD PATTERN



#### **CIRCUIT DIAGRAM**





#### PRODUCT IDENTIFICATION

VLF	302512M	Т	-	1R0	Ν
(1)	(2)	(3)	-	(4)	(5)

- (1) Series name
- (2) Dimensions L×W×H mm max.

#### (3) Packaging style

T	Taping (Embossed carrier tape)
(4) Inductance value	
1R0	1.0μΗ
100	10μΗ
(5) Inductance tolera	nce

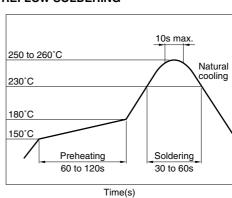
+20%

### PACKAGING STYLE AND QUANTITIES

Packaging style	Quantity
Taping	2000 pieces/reel

#### HANDLING AND PRECAUTIONS

- Before soldering, be sure to preheat components.
   The preheating temperature should be set so that the temperature difference between the solder temperature and product temperature does not exceed 150°C.
- When hand soldering, apply the soldering iron to the printed circuit board only. Temperature of the iron tip should not exceed 350°C. Soldering time should not exceed 3 seconds.

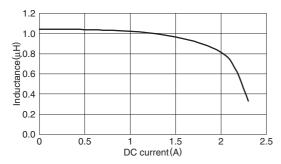


- Conformity to RoHS Directive: This means that, in conformity with EU Directive 2002/95/EC, lead, cadmium, mercury, hexavalent chromium, and specific bromine-based flame retardants, PBB and PBDE, have not been used, except for exempted applications.
- Please contact our Sales office when your application is considered the following:
   The device's failure or malfunction may directly endanger human life (e.g. application for automobile/aircraft/medical/nuclear power devices, etc.)

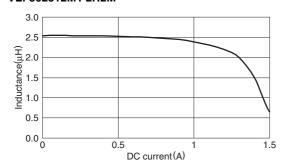
				DC resistance( $\Omega$ )		Rated current*(A)			
Part No.		Inductance tolerance(%)	Test frequency (MHz)	max.	ıx. typ.	Based on inductance change Idc1		Based on temperature rise Idc2	
						max.	typ.	typ.	
VLF302512MT-1R0N	1.0	±30	1.0	0.037	0.031	1.91	2.12	2.77	
VLF302512MT-1R5N	1.5	±30	1.0	0.044	0.037	1.67	1.85	2.54	
VLF302512MT-2R2M	2.2	±20	1.0	0.066	0.055	1.26	1.40	1.95	
VLF302512MT-3R3M	3.3	±20	1.0	0.108	0.090	1.08	1.20	1.63	
VLF302512MT-4R7M	4.7	±20	1.0	0.136	0.113	0.97	1.08	1.42	
VLF302512MT-6R8M	6.8	±20	1.0	0.194	0.162	0.78	0.84	1.21	
VLF302512MT-100M	10	±20	1.0	0.299	0.249	0.62	0.69	0.95	
VLF302512MT-150M	15	±20	1.0	0.448	0.373	0.51	0.57	0.80	
VLF302512MT-220M	22	±20	1.0	0.700	0.583	0.43	0.47	0.64	

<sup>\*</sup> Rated current: Value obtained when current flows and the temperature has risen to 40°C or when DC current flows and the nominal value of inductance has fallen by 30%, whichever is smaller.

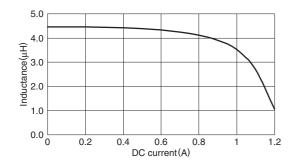
# TYPICAL ELECTRICAL CHARACTERISTICS INDUCTANCE vs. DC SUPERPOSITION CHARACTERISTICS VLF302512MT-1R0N



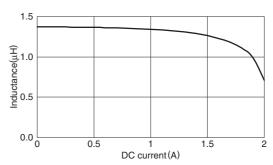
### VLF302512MT-2R2M



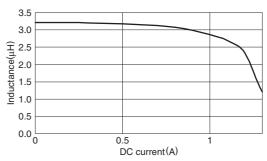
# VLF302512MT-4R7M



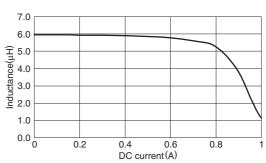
#### VLF302512MT-1R5N



#### VLF302512MT-3R3M



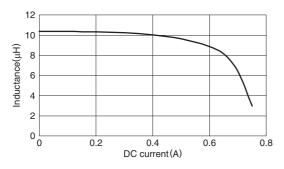
#### VLF302512MT-6R8M



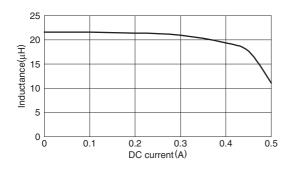
<sup>•</sup> Operating temperature range: -40 to +105°C (Including self-temperature rise)

<sup>•</sup> All specifications are subject to change without notice.

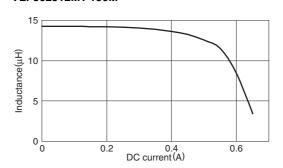
# TYPICAL ELECTRICAL CHARACTERISTICS INDUCTANCE vs. DC SUPERPOSITION CHARACTERISTICS VLF302512MT-100M



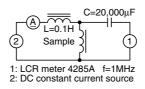
#### VLF302512MT-220M



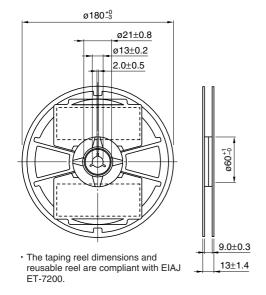
#### VLF302512MT-150M



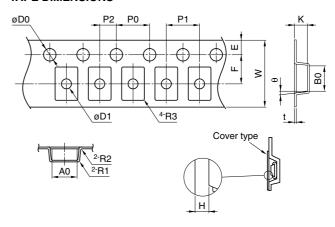
#### **TEST CIRCUIT**



# PACKAGING STYLES REEL DIMENSIONS



Dimensions in mm



				Dimensions in mm
A0	B0	W	F	Е
2.8typ.	3.3typ.	8.00± 0.2	3.50± 0.1	1.75± 0.1
P1	P2	Н	P0	øD0
4.00± 0.1	2.00±0.05	0.05 to 0.35	4.0±0.1	1.5+0.1/-0
K	øD1	t	R1 to R3	θ
1.35±0.1	1.2±0.2	0.25±0.05	0.3max.	5° typ.

# **&TDK**

# Inductors for Power Circuits Wound/STD • Magnetic Shielded

## **Conformity to RoHS Directive**

#### VLF Series VLF302515MT

With the VLF302515MT Series, a DC to DC converter with topclass voltage conversion efficiency for similar size products was achieved by optimizing the magnetic material and configuration. These products are optimal for use as choke coils in switching power supplies such as those in mobile devices requiring spacesaving design.

#### **FEATURES**

Miniature size

Mount area: 3.0×2.5mm

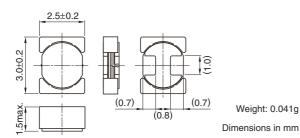
Low profile: 1.5mm max. height

- Generic use for portable DC to DC converter line.
- High magnetic shield construction should actualize high resolution for EMC protection.
- The products contain no lead and also support lead-free soldering.
- The products is halogen-free.
- · It is a product conforming to RoHS directive.

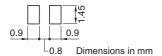
#### **APPLICATIONS**

Smartphones, cellular phones, DSCs, DVCs, HDDs, LCD displays, compact power supply modules, etc.

#### **SHAPES AND DIMENSIONS**



#### **RECOMMENDED PC BOARD PATTERN**



#### CIRCUIT DIAGRAM





#### PRODUCT IDENTIFICATION

VLF	302515M	Т	-	1R0	Ν
(1)	(2)	(3)		(4)	(5)

- (1) Series name
- (2) Dimensions L×W×H mm max.

#### (3) Packaging style

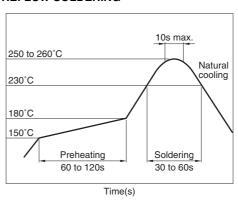
Т	raping (Embossed carrier tape)
(4) Inductance value	
1R0	1.0μΗ
100	10μΗ
(5) Inductance tolerance	
M	±20%

#### **PACKAGING STYLE AND QUANTITIES**

Packaging style	Quantity
Taping	2000 pieces/reel

#### HANDLING AND PRECAUTIONS

- Before soldering, be sure to preheat components.
   The preheating temperature should be set so that the temperature difference between the solder temperature and product temperature does not exceed 150°C.
- When hand soldering, apply the soldering iron to the printed circuit board only. Temperature of the iron tip should not exceed 350°C. Soldering time should not exceed 3 seconds.



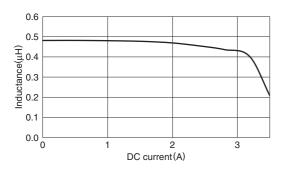
- Conformity to RoHS Directive: This means that, in conformity with EU Directive 2002/95/EC, lead, cadmium, mercury, hexavalent chromium, and specific bromine-based flame retardants, PBB and PBDE, have not been used, except for exempted applications.
- Please contact our Sales office when your application is considered the following:

  The device's failure or malfunction may directly endanger human life (e.g. application for automobile/aircraft/medical/nuclear power devices, etc.)

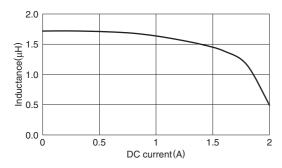
				DC resistance( $\Omega$ )		Rated current*(A)		
Part No.		Inductance tolerance(%)		max.	nax. typ.	Based on inductance change Idc1		Based on temperature rise Idc2
						max.	typ.	typ.
VLF302515MT-R47N	0.47	±30	1.0	0.020	0.017	2.88	3.18	4.00
VLF302515MT-1R0N	1.0	±30	1.0	0.030	0.025	1.94	2.15	3.31
VLF302515MT-1R5N	1.5	±30	1.0	0.038	0.032	1.66	1.84	3.14
VLF302515MT-2R2M	2.2	±20	1.0	0.050	0.042	1.41	1.57	2.71
VLF302515MT-3R3M	3.3	±20	1.0	0.072	0.060	1.11	1.23	2.25
VLF302515MT-4R7M	4.7	±20	1.0	0.090	0.075	0.93	1.03	1.95
VLF302515MT-6R8M	6.8	±20	1.0	0.16	0.13	0.77	0.86	1.45
VLF302515MT-100M	10.0	±20	1.0	0.18	0.15	0.64	0.71	1.37
VLF302515MT-150M	15.0	±20	1.0	0.33	0.28	0.50	0.56	0.99
VLF302515MT-220M	22.0	±20	1.0	0.49	0.41	0.41	0.46	0.75

<sup>\*</sup> Rated current: Value obtained when current flows and the temperature has risen to 40°C or when DC current flows and the nominal value of inductance has fallen by 30%, whichever is smaller.

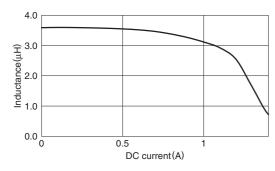
# TYPICAL ELECTRICAL CHARACTERISTICS INDUCTANCE vs. DC SUPERPOSITION CHARACTERISTICS VLF302515MT-R47N



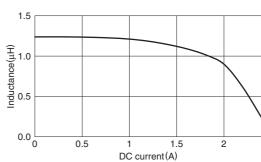
#### VLF302515MT-1R5N



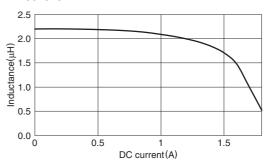
### VLF302515MT-3R3M



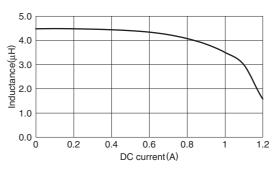
#### VLF302515MT-1R0N



#### VLF302515MT-2R2M



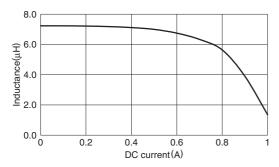
### VLF302515MT-4R7M



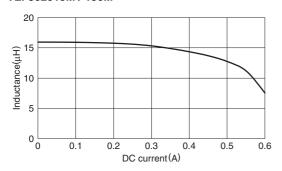
<sup>•</sup> Operating temperature range: -40 to +105°C (Including self-temperature rise)

<sup>•</sup> All specifications are subject to change without notice.

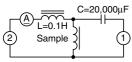
### TYPICAL ELECTRICAL CHARACTERISTICS INDUCTANCE vs. DC SUPERPOSITION CHARACTERISTICS VLF302515MT-6R8M



#### VLF302515MT-150M

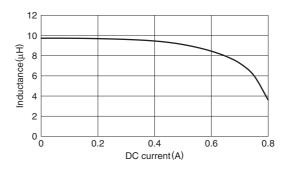


#### **TEST CIRCUIT**

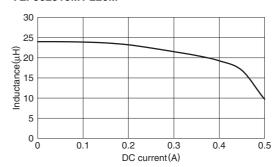


1: LCR meter 4285A f=1MHz 2: DC constant current source

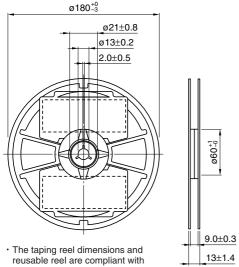
#### VLF302515MT-100M



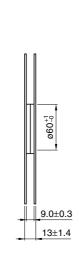
#### VLF302515MT-220M



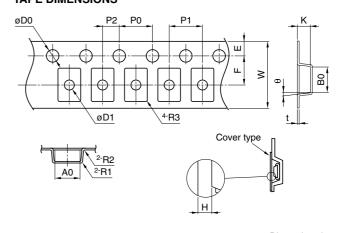
### **PACKAGING STYLES REEL DIMENSIONS**



• The taping reel dimensions and reusable reel are compliant with EIAJ ET-7200.



Dimensions in mm



Dimensions in mm	
------------------	--

A0	B0	W	F	E
2.8typ.	3.3typ.	8.00±0.2	3.50±0.1	1.75±0.1
P1	P2	Н	P0	øD0
4.00±0.1	2.00±0.05	0.05 to 0.35	4.0±0.1	1.5+0.1/-0
,				
K	øD1	t	R1 to R3	θ
1.65±0.1	1.2±0.2	0.25±0.05	0.3max.	5° typ.

# **ATDK**

# Inductors for Power Circuits Wound/STD • Magnetic Shielded

**Conformity to RoHS Directive** 

### VLF Series VLF403210MT

With the VLF403210MT Series, a DC to DC converter with topclass voltage conversion efficiency for similar size products was achieved by optimizing the magnetic material and configuration. These products are optimal for use as choke coils in switching power supplies such as those in mobile devices requiring spacesaving design.

#### **FEATURES**

Miniature size

Mount area: 4.0×3.2mm

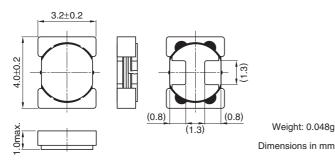
Low profile: 1.0mm max. height

- Generic use for portable DC to DC converter line.
- High magnetic shield construction should actualize high resolution for EMC protection.
- The products contain no lead and also support lead-free soldering.
- The products is halogen-free.
- · It is a product conforming to RoHS directive.

#### **APPLICATIONS**

Smartphones, cellular phones, DSCs, DVCs, HDDs, LCD displays, compact power supply modules, etc.

#### **SHAPES AND DIMENSIONS**



#### RECOMMENDED PC BOARD PATTERN



#### **CIRCUIT DIAGRAM**





#### PRODUCT IDENTIFICATION

VLF	403210M	Т	-	1R0	Ν
(1)	(2)	(3)		(4)	(5)

- (1) Series name
- (2) Dimensions L×W×H mm max.

#### (3) Packaging style

Т	Taping (Embossed carrier tape)
(4) Inductance value	
1R0	1.0μΗ
100	10μΗ
(5) Inductance tolera	nce

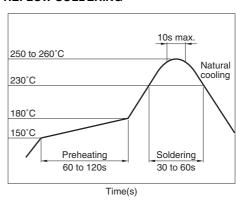
+20%

#### **PACKAGING STYLE AND QUANTITIES**

Packaging style	Quantity
Taping	1000 pieces/reel

#### HANDLING AND PRECAUTIONS

- Before soldering, be sure to preheat components.
   The preheating temperature should be set so that the temperature difference between the solder temperature and product temperature does not exceed 150°C.
- When hand soldering, apply the soldering iron to the printed circuit board only. Temperature of the iron tip should not exceed 350°C. Soldering time should not exceed 3 seconds.



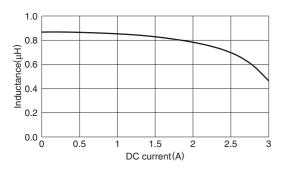
- Conformity to RoHS Directive: This means that, in conformity with EU Directive 2002/95/EC, lead, cadmium, mercury, hexavalent chromium, and specific bromine-based flame retardants, PBB and PBDE, have not been used, except for exempted applications.
- Please contact our Sales office when your application is considered the following:

  The device's failure or malfunction may directly endanger human life (e.g. application for automobile/aircraft/medical/nuclear power devices, etc.)

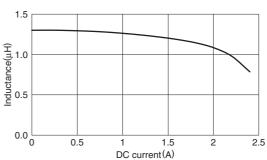
				DC resistance( $\Omega$ )		Rated current*(A)			
Part No.		Inductance tolerance(%)	Test frequency (MHz)	max.	typ.	Based on inductance change Idc1		Based on temperature rise Idc2	
						max.	typ.	typ.	
VLF403210MT-1R0N	1.0	±30	1.0	0.032	0.026	2.23	2.48	3.44	
VLF403210MT-1R5N	1.5	±30	1.0	0.043	0.036	1.85	2.06	2.96	
VLF403210MT-2R2M	2.2	±20	1.0	0.066	0.055	1.59	1.77	2.33	
VLF403210MT-3R3M	3.3	±20	1.0	0.098	0.082	1.19	1.32	1.95	
VLF403210MT-4R7M	4.7	±20	1.0	0.14	0.12	1.09	1.21	1.61	
VLF403210MT-6R8M	6.8	±20	1.0	0.22	0.18	0.84	0.93	1.24	
VLF403210MT-100M	10.0	±20	1.0	0.31	0.26	0.70	0.78	1.04	
VLF403210MT-150M	15.0	±20	1.0	0.49	0.40	0.59	0.66	0.83	
VLF403210MT-220M	22.0	±20	1.0	0.72	0.60	0.46	0.51	0.68	

<sup>\*</sup> Rated current: Value obtained when current flows and the temperature has risen to 40°C or when DC current flows and the nominal value of inductance has fallen by 30%, whichever is smaller.

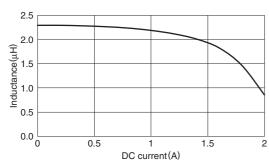
# TYPICAL ELECTRICAL CHARACTERISTICS INDUCTANCE vs. DC SUPERPOSITION CHARACTERISTICS VLF403210MT-1R0N



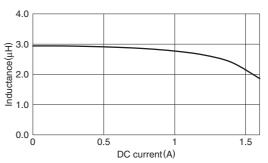
# VLF403210MT-1R5N



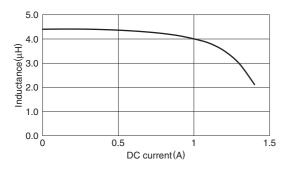
#### VLF403210MT-2R2M



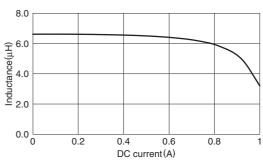
#### VLF403210MT-3R3M



#### VLF403210MT-4R7M



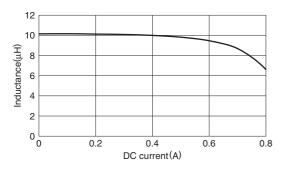
#### VLF403210MT-6R8M



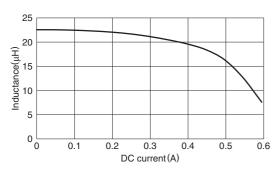
<sup>•</sup> Operating temperature range: -40 to +105°C (Including self-temperature rise)

<sup>•</sup> All specifications are subject to change without notice.

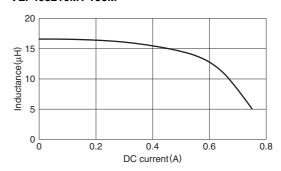
## TYPICAL ELECTRICAL CHARACTERISTICS INDUCTANCE vs. DC SUPERPOSITION CHARACTERISTICS VLF403210MT-100M



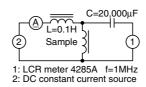
#### VLF403210MT-220M



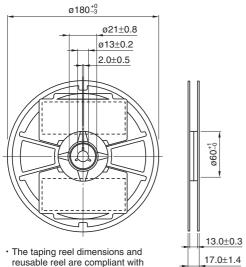
#### VLF403210MT-150M



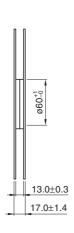
#### **TEST CIRCUIT**



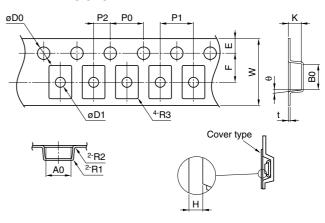
### **PACKAGING STYLES REEL DIMENSIONS**



• The taping reel dimensions and reusable reel are compliant with EIAJ ET-7200.



Dimensions in mm



				Dimensions in mm
A0	В0	W	F	E
3.65typ.	4.45typ.	12.00±0.2	5.50±0.1	1.75±0.1
P1	P2	Н	P0	øD0
8.00±0.1	2.00±0.05	0.05 to 0.35	4.0±0.1	1.5+0.1/-0
K	øD1	t	R1 to R3	θ
1.15±0.1	1.2±0.2	0.25±0.05	0.3max.	5° typ.
1.15±0.1	1.2±0.2	0.25±0.05	0.3max.	5° typ.

# **ATDK**

# Inductors for Power Circuits Wound/STD • Magnetic Shielded

**Conformity to RoHS Directive** 

#### VLF Series VLF403212MT

With the VLF403212MT Series, a DC to DC converter with topclass voltage conversion efficiency for similar size products was achieved by optimizing the magnetic material and configuration. These products are optimal for use as choke coils in switching power supplies such as those in mobile devices requiring spacesaving design.

#### **FEATURES**

Miniature size

Mount area: 4.0×3.2mm

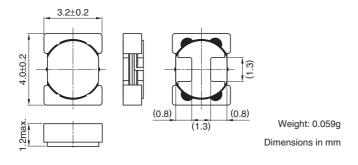
Low profile: 1.2mm max. height

- Generic use for portable DC to DC converter line.
- High magnetic shield construction should actualize high resolution for EMC protection.
- The products contain no lead and also support lead-free soldering.
- · The products is halogen-free.
- · It is a product conforming to RoHS directive.

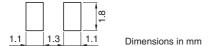
#### **APPLICATIONS**

Smartphones, cellular phones, DSCs, DVCs, HDDs, LCD displays, compact power supply modules, etc.

#### **SHAPES AND DIMENSIONS**



#### RECOMMENDED PC BOARD PATTERN



#### **CIRCUIT DIAGRAM**





#### PRODUCT IDENTIFICATION

VLF	403212M	Τ .	- 1R0	Ν
(1)	(2)	(3)	(4)	(5)

- (1) Series name
- (2) Dimensions L×W×H mm max.

#### (3) Packaging style

М

ape)	
	ctance value
	ctance tolerance

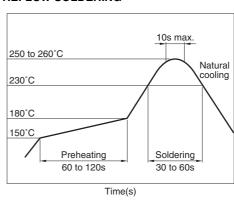
+20%

# PACKAGING STYLE AND QUANTITIES

Packaging style	Quantity
Taping	1000 pieces/reel

#### HANDLING AND PRECAUTIONS

- Before soldering, be sure to preheat components.
   The preheating temperature should be set so that the temperature difference between the solder temperature and product temperature does not exceed 150°C.
- When hand soldering, apply the soldering iron to the printed circuit board only. Temperature of the iron tip should not exceed 350°C. Soldering time should not exceed 3 seconds.



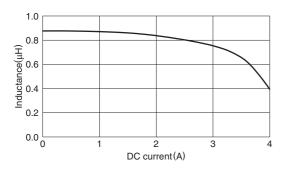
- Conformity to RoHS Directive: This means that, in conformity with EU Directive 2002/95/EC, lead, cadmium, mercury, hexavalent chromium, and specific bromine-based flame retardants, PBB and PBDE, have not been used, except for exempted applications.
- Please contact our Sales office when your application is considered the following:

  The device's failure or malfunction may directly endanger human life (e.g. application for automobile/aircraft/medical/nuclear power devices, etc.)

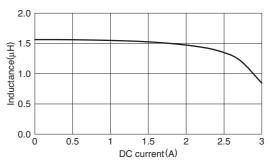
				DC resis	DC resistance(Ω) Rated current*(A)			
Part No.	Inductance (µH)	Inductance tolerance(%)	Test frequency (MHz)	max.	max. typ.	Based on inductance change Idc1		Based on temperature rise Idc2
						max.	typ.	typ.
VLF403212MT-1R0N	1.0	±30	1.0	0.031	0.026	3.00	3.33	3.62
VLF403212MT-1R5N	1.5	±30	1.0	0.050	0.042	2.41	2.68	2.98
VLF403212MT-2R2M	2.2	±20	1.0	0.065	0.054	2.05	2.28	2.48
VLF403212MT-3R3M	3.3	±20	1.0	0.091	0.076	1.65	1.83	1.91
VLF403212MT-4R7M	4.7	±20	1.0	0.12	0.096	1.40	1.56	1.85
VLF403212MT-6R8M	6.8	±20	1.0	0.18	0.15	1.09	1.22	1.33
VLF403212MT-100M	10.0	±20	1.0	0.28	0.23	0.90	1.00	1.07
VLF403212MT-150M	15.0	±20	1.0	0.42	0.35	0.74	0.82	0.87
VLF403212MT-220M	22.0	±20	1.0	0.71	0.59	0.54	0.60	0.67

<sup>\*</sup> Rated current: Value obtained when current flows and the temperature has risen to 40°C or when DC current flows and the nominal value of inductance has fallen by 30%, whichever is smaller.

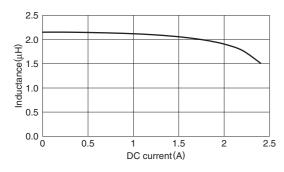
# TYPICAL ELECTRICAL CHARACTERISTICS INDUCTANCE vs. DC SUPERPOSITION CHARACTERISTICS VLF403212MT-1R0N



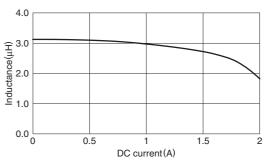
### VLF403212MT-1R5N



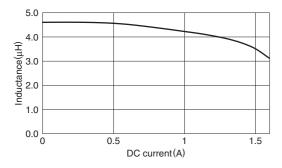
#### VLF403212MT-2R2M



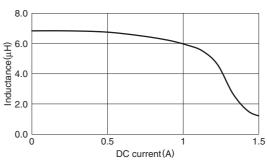
#### VLF403212MT-3R3M



#### VLF403212MT-4R7M



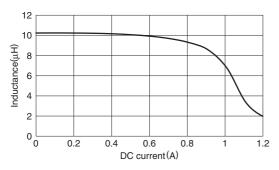
#### VLF403212MT-6R8M



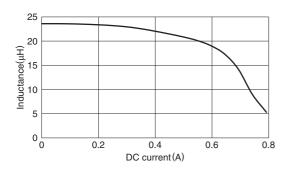
<sup>•</sup> Operating temperature range: -40 to +105°C (Including self-temperature rise)

<sup>•</sup> All specifications are subject to change without notice.

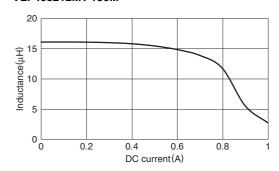
# TYPICAL ELECTRICAL CHARACTERISTICS INDUCTANCE vs. DC SUPERPOSITION CHARACTERISTICS VLF403212MT-100M



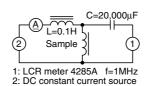
#### VLF403212MT-220M



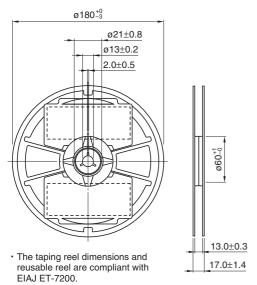
#### VLF403212MT-150M



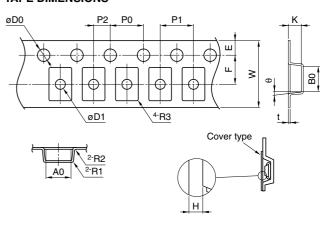
#### **TEST CIRCUIT**



# PACKAGING STYLES REEL DIMENSIONS



Dimensions in mm



				Dimensions in mm
A0	B0	W	F	Е
3.65typ.	4.45typ.	12.00±0.2	5.50±0.1	1.75±0.1
P1	P2	Н	P0	øD0
8.00±0.1	2.00±0.05	0.05 to 0.35	4.0±0.1	1.5+0.1/-0
K	øD1	t	R1 to R3	θ
1.35±0.1	1.2±0.2	0.25±0.05	0.3max.	5° typ.

# Inductors for Power Circuits Wound/STD • Magnetic Shielded

**Conformity to RoHS Directive** 

#### VLF Series VLF403215MT

With the VLF403215MT Series, a DC to DC converter with topclass voltage conversion efficiency for similar size products was achieved by optimizing the magnetic material and configuration. These products are optimal for use as choke coils in switching power supplies such as those in mobile devices requiring spacesaving design.

#### **FEATURES**

Miniature size

Mount area: 4.0×3.2mm

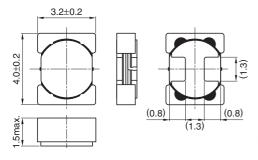
Low profile: 1.5mm max. height

- Generic use for portable DC to DC converter line.
- High magnetic shield construction should actualize high resolution for EMC protection.
- The products contain no lead and also support lead-free soldering.
- The products is halogen-free.
- · It is a product conforming to RoHS directive.

#### **APPLICATIONS**

Smartphones, cellular phones, DSCs, DVCs, HDDs, LCD displays, compact power supply modules, etc.

### SHAPES AND DIMENSIONS



Weight: 0.072g
Dimensions in mm

#### RECOMMENDED PC BOARD PATTERN



Dimensions in mm

### **CIRCUIT DIAGRAM**





#### PRODUCT IDENTIFICATION

VLF	LF 403215M		1R0	Ν
(1)	(2)	(3)	(4)	(5)

- (1) Series name
- (2) Dimensions L×W×H mm max.

#### (3) Packaging style

T	(Embossed carrier tape)				
(4) Inductance value					
1R0	1.0μΗ				
	10uH				

#### (5) Inductance tolerance

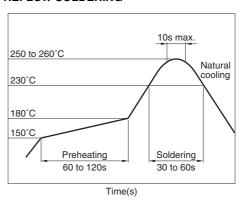
M	±20%	
N	±30%	

#### **PACKAGING STYLE AND QUANTITIES**

Packaging style	Quantity
Taping	1000 pieces/reel

### HANDLING AND PRECAUTIONS

- Before soldering, be sure to preheat components.
   The preheating temperature should be set so that the temperature difference between the solder temperature and product temperature does not exceed 150°C.
- When hand soldering, apply the soldering iron to the printed circuit board only. Temperature of the iron tip should not exceed 350°C. Soldering time should not exceed 3 seconds.

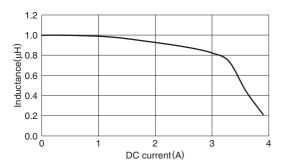


- Conformity to RoHS Directive: This means that, in conformity with EU Directive 2002/95/EC, lead, cadmium, mercury, hexavalent chromium, and specific bromine-based flame retardants, PBB and PBDE, have not been used, except for exempted applications.
- Please contact our Sales office when your application is considered the following:
   The device's failure or malfunction may directly endanger human life (e.g. application for automobile/aircraft/medical/nuclear power devices, etc.)

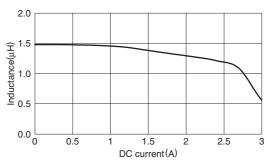
				DC resistance( $\Omega$ ) Rated cu		ırrent*(A)		
Part No.	Inductance (µH)	Inductance tolerance(%)	Test frequency (MHz)	max.	max. typ.	Based on inductance change Idc1		Based on temperature rise Idc2
						max.	typ.	typ.
VLF403215MT-1R0N	1.0	±30	1.0	0.031	0.026	3.01	3.34	3.56
VLF403215MT-1R5N	1.5	±30	1.0	0.036	0.030	2.46	2.73	3.38
VLF403215MT-2R2M	2.2	±20	1.0	0.043	0.036	2.03	2.25	3.14
VLF403215MT-3R3M	3.3	±20	1.0	0.062	0.051	1.65	1.83	2.65
VLF403215MT-4R7M	4.7	±20	1.0	0.087	0.073	1.39	1.54	2.13
VLF403215MT-6R8M	6.8	±20	1.0	0.13	0.11	1.14	1.27	1.68
VLF403215MT-100M	10.0	±20	1.0	0.18	0.15	1.00	1.09	1.44
VLF403215MT-150M	15.0	±20	1.0	0.26	0.22	0.78	0.87	1.19
VLF403215MT-220M	22.0	±20	1.0	0.38	0.32	0.65	0.72	0.95

<sup>\*</sup> Rated current: Value obtained when current flows and the temperature has risen to 40°C or when DC current flows and the nominal value of inductance has fallen by 30%, whichever is smaller.

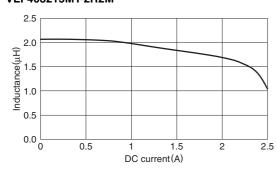
# TYPICAL ELECTRICAL CHARACTERISTICS INDUCTANCE vs. DC SUPERPOSITION CHARACTERISTICS VLF403215MT-1R0N



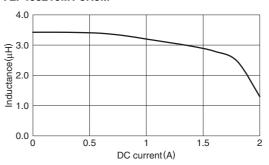
### VLF403215MT-1R5N



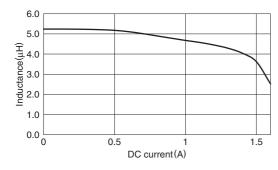
### VLF403215MT-2R2M



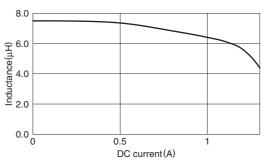
#### VLF403215MT-3R3M



#### VLF403215MT-4R7M



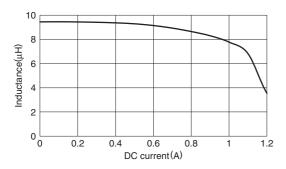
#### VLF403215MT-6R8M



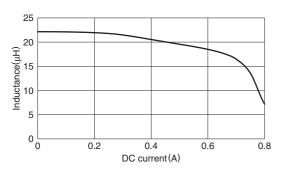
<sup>•</sup> Operating temperature range: -40 to +105°C (Including self-temperature rise)

<sup>•</sup> All specifications are subject to change without notice.

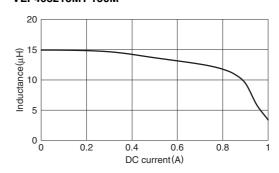
## TYPICAL ELECTRICAL CHARACTERISTICS INDUCTANCE vs. DC SUPERPOSITION CHARACTERISTICS VLF403215MT-100M



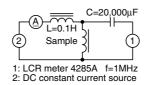
#### VLF403215MT-220M



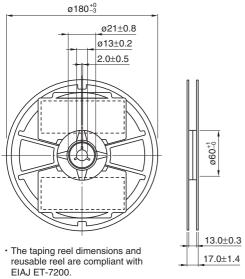
#### VLF403215MT-150M

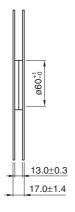


#### **TEST CIRCUIT**

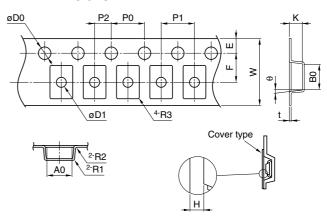


### **PACKAGING STYLES REEL DIMENSIONS**





Dimensions in mm



				Dimensions in mm
A0	В0	W	F	E
3.65typ.	4.45typ.	12.00±0.2	5.50±0.1	1.75±0.1
				_
P1	P2	Н	P0	øD0
8.00±0.1	2.00±0.05	0.05 to 0.35	4.0±0.1	1.5+0.1/-0
K	øD1	+	R1 to R3	θ
1.65±0.1	1.2±0.2	0.25±0.05	0.3max.	5° typ.
				- 71.

# Inductors for Power Circuits Wound/STD • Magnetic Shielded

## **Conformity to RoHS Directive**

### VLF Series VLF504010MT

With the VLF504010MT Series, a DC to DC converter with topclass voltage conversion efficiency for similar size products was achieved by optimizing the magnetic material and configuration. These products are optimal for use as choke coils in switching power supplies such as those in mobile devices requiring spacesaving design.

#### **FEATURES**

Miniature size

Mount area: 5.0×4.0mm

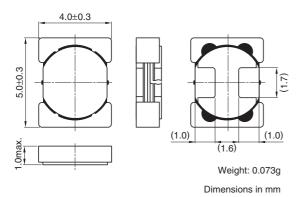
Low profile: 1.0mm max. height

- Generic use for portable DC to DC converter line.
- High magnetic shield construction should actualize high resolution for EMC protection.
- The products contain no lead and also support lead-free soldering.
- The products is halogen-free.
- · It is a product conforming to RoHS directive.

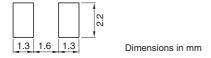
#### **APPLICATIONS**

Smartphones, cellular phones, DSCs, DVCs, HDDs, LCD displays, compact power supply modules, etc.

#### **SHAPES AND DIMENSIONS**



#### RECOMMENDED PC BOARD PATTERN



#### **CIRCUIT DIAGRAM**





#### PRODUCT IDENTIFICATION

VLF	504010M	Т	- 1R0	Ν
(1)	(2)	(3)	(4)	(5)

- (1) Series name
- (2) Dimensions L×W×H mm max.

#### (3) Packaging style

T	Taping (Embossed carrier tape)
(4) Inductance value	
1R0	1.0μΗ
100	10μΗ
(5) Inductance tolerance	е
M	±20%

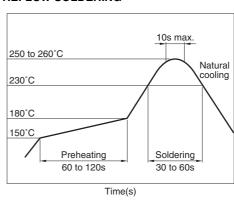
#### **PACKAGING STYLE AND QUANTITIES**

Packaging style	Quantity
Taping	1000 pieces/reel

±30%

#### HANDLING AND PRECAUTIONS

- Before soldering, be sure to preheat components.
   The preheating temperature should be set so that the temperature difference between the solder temperature and product temperature does not exceed 150°C.
- When hand soldering, apply the soldering iron to the printed circuit board only. Temperature of the iron tip should not exceed 350°C. Soldering time should not exceed 3 seconds.

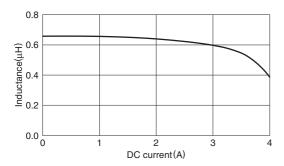


- Conformity to RoHS Directive: This means that, in conformity with EU Directive 2002/95/EC, lead, cadmium, mercury, hexavalent chromium, and specific bromine-based flame retardants, PBB and PBDE, have not been used, except for exempted applications.
- Please contact our Sales office when your application is considered the following:
   The device's failure or malfunction may directly endanger human life (e.g. application for automobile/aircraft/medical/nuclear power devices, etc.)

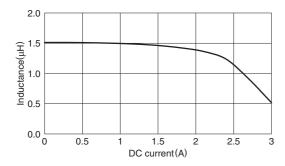
				DC resistance( $\Omega$ )		Rated current*(A)		
Part No.		Inductance Test frequency tolerance(%) (MHz)	max.	max. typ.	Based on inductance change Idc1		Based on temperature rise Idc2	
						max.	typ.	typ.
VLF504010MT-R68N	0.68	±30	1.0	0.030	0.025	3.40	3.78	3.71
VLF504010MT-1R0N	1.0	±30	1.0	0.037	0.031	2.66	2.95	3.08
VLF504010MT-1R5N	1.5	±30	1.0	0.044	0.037	2.30	2.56	2.86
VLF504010MT-2R2M	2.2	±20	1.0	0.054	0.045	1.92	2.14	2.65
VLF504010MT-3R3M	3.3	±20	1.0	0.091	0.076	1.58	1.75	2.10
VLF504010MT-4R7M	4.7	±20	1.0	0.12	0.10	1.32	1.47	1.77
VLF504010MT-6R8M	6.8	±20	1.0	0.19	0.16	1.09	1.21	1.40
VLF504010MT-100M	10.0	±20	1.0	0.25	0.21	0.90	1.00	1.21
VLF504010MT-150M	15.0	±20	1.0	0.40	0.33	0.74	0.83	0.98
VLF504010MT-220M	22.0	±20	1.0	0.60	0.50	0.61	0.68	0.78

<sup>\*</sup> Rated current: Value obtained when current flows and the temperature has risen to 40°C or when DC current flows and the nominal value of inductance has fallen by 30%, whichever is smaller.

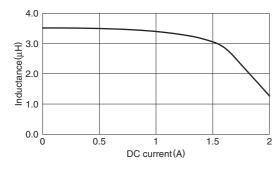
# TYPICAL ELECTRICAL CHARACTERISTICS INDUCTANCE vs. DC SUPERPOSITION CHARACTERISTICS VLF504010MT-R68N



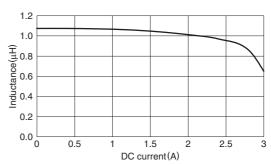
### VLF504010MT-1R5N



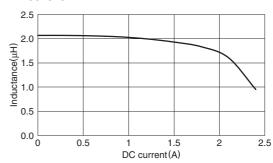
## VLF504010MT-3R3M



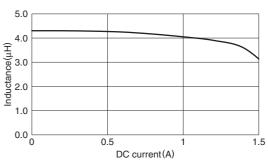
#### VLF504010MT-1R0N



#### VLF504010MT-2R2M



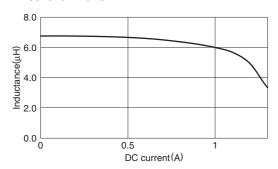
### VLF504010MT-4R7M



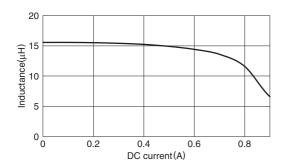
<sup>•</sup> Operating temperature range: -40 to +105°C (Including self-temperature rise)

<sup>•</sup> All specifications are subject to change without notice.

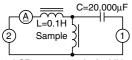
# TYPICAL ELECTRICAL CHARACTERISTICS INDUCTANCE vs. DC SUPERPOSITION CHARACTERISTICS VLF504010MT-6R8M



#### VLF504010MT-150M

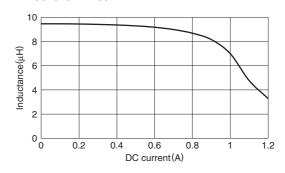


#### **TEST CIRCUIT**

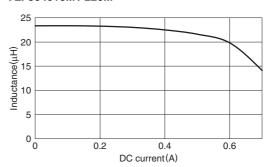


1: LCR meter 4285A f=1MHz 2: DC constant current source

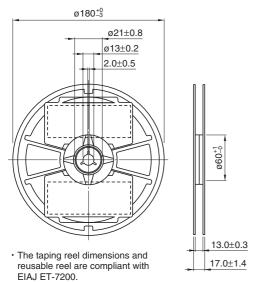
#### VLF504010MT-100M



#### VLF504010MT-220M



# PACKAGING STYLES REEL DIMENSIONS



Dimensions in mm

A0

4.45typ.

8.00±0.1

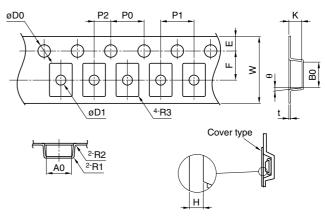
B0

5.45typ.

P2

2.00±0.05

#### **TAPE DIMENSIONS**



F	E
5.50±0.1	1.75±0.1
P0	øD0
4.0±0.1	1.5+0.1/-0

Dimensions in mm

K	øD1	t	R1 to R3	θ	
1.15±0.1	1.2±0.2	0.25±0.05	0.3max.	5° typ.	

W

12.00±0.2

H 0.05 to 0.35

# Inductors for Power Circuits Wound/STD • Magnetic Shielded

**Conformity to RoHS Directive** 

#### VLF Series VLF504012MT

With the VLF504012MT Series, a DC to DC converter with topclass voltage conversion efficiency for similar size products was achieved by optimizing the magnetic material and configuration. These products are optimal for use as choke coils in switching power supplies such as those in mobile devices requiring spacesaving design.

#### **FEATURES**

Miniature size

Mount area: 5.0×4.0mm

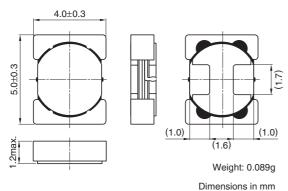
Low profile: 1.2mm max. height

- Generic use for portable DC to DC converter line.
- High magnetic shield construction should actualize high resolution for EMC protection.
- The products contain no lead and also support lead-free soldering.
- · The products is halogen-free.
- · It is a product conforming to RoHS directive.

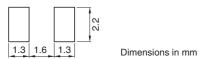
#### **APPLICATIONS**

Smartphones, cellular phones, DSCs, DVCs, HDDs, LCD displays, compact power supply modules, etc.

### SHAPES AND DIMENSIONS



#### RECOMMENDED PC BOARD PATTERN



#### **CIRCUIT DIAGRAM**





#### PRODUCT IDENTIFICATION

VLF	504012M	Т -	1R0	Ν
(1)	(2)	(3)	(4)	(5)

- (1) Series name
- (2) Dimensions L×W×H mm max.

#### (3) Packaging style

T 	Taping (Embossed carrier tape)
(4) Inductance value	
1R0	1.0μΗ
100	10μΗ
(5) Inductance tolera	nce

±20%

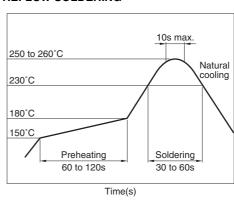
#### IN ±3

PACKAGING STYLE AND QUANTITIES

Packaging style	Quantity				
Taning	1000 niaces/real				

#### HANDLING AND PRECAUTIONS

- Before soldering, be sure to preheat components.
   The preheating temperature should be set so that the temperature difference between the solder temperature and product temperature does not exceed 150°C.
- When hand soldering, apply the soldering iron to the printed circuit board only. Temperature of the iron tip should not exceed 350°C. Soldering time should not exceed 3 seconds.

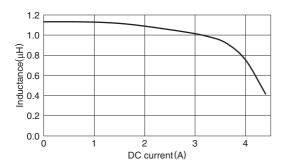


- Conformity to RoHS Directive: This means that, in conformity with EU Directive 2002/95/EC, lead, cadmium, mercury, hexavalent chromium, and specific bromine-based flame retardants, PBB and PBDE, have not been used, except for exempted applications.
- Please contact our Sales office when your application is considered the following:
   The device's failure or malfunction may directly endanger human life (e.g. application for automobile/aircraft/medical/nuclear power devices, etc.)

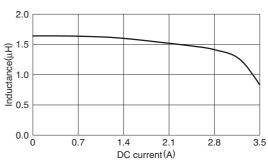
			DC resistance( $\Omega$ )		Rated current*(A)			
Part No.	Inductance (µH)		Test frequency (MHz)	max.	max. typ.	Based on inductance change Idc1		Based on temperature rise Idc2
						max.	typ.	typ.
VLF504012MT-1R0N	1.0	±30	1.0	0.038	0.032	3.67	4.08	3.19
VLF504012MT-1R5N	1.5	±30	1.0	0.048	0.040	3.02	3.36	2.91
VLF504012MT-2R2M	2.2	±20	1.0	0.055	0.046	2.54	2.82	2.71
VLF504012MT-3R3M	3.3	±20	1.0	0.074	0.062	2.13	2.37	2.47
VLF504012MT-4R7M	4.7	±20	1.0	0.12	0.10	1.75	1.94	1.83
VLF504012MT-6R8M	6.8	±20	1.0	0.17	0.14	1.48	1.64	1.77
VLF504012MT-100M	10.0	±20	1.0	0.23	0.19	1.18	1.32	1.30
VLF504012MT-150M	15.0	±20	1.0	0.32	0.27	1.01	1.12	1.08
VLF504012MT-220M	22.0	±20	1.0	0.58	0.48	0.80	0.89	0.84

<sup>\*</sup> Rated current: Value obtained when current flows and the temperature has risen to 40°C or when DC current flows and the nominal value of inductance has fallen by 30%, whichever is smaller.

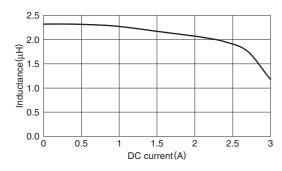
# TYPICAL ELECTRICAL CHARACTERISTICS INDUCTANCE vs. DC SUPERPOSITION CHARACTERISTICS VLF504012MT-1R0N



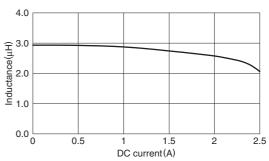
# VLF504012MT-1R5N



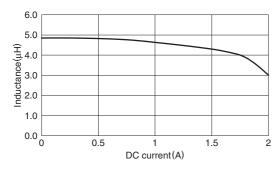
#### VLF504012MT-2R2M



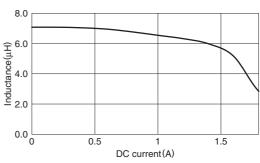
#### VLF504012MT-3R3M



#### VLF504012MT-4R7M



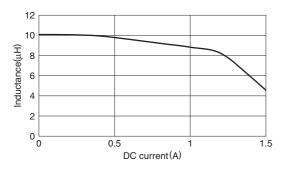
#### VLF504012MT-6R8M



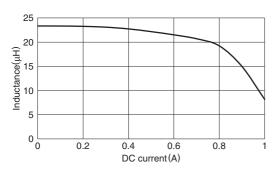
<sup>•</sup> Operating temperature range: -40 to +105°C (Including self-temperature rise)

<sup>•</sup> All specifications are subject to change without notice.

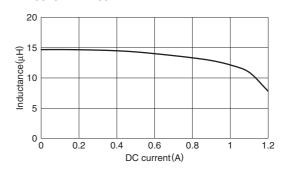
## TYPICAL ELECTRICAL CHARACTERISTICS INDUCTANCE vs. DC SUPERPOSITION CHARACTERISTICS VLF504012MT-100M



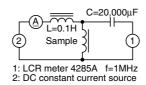
#### VLF504012MT-220M



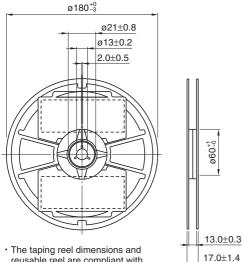
#### VLF504012MT-150M



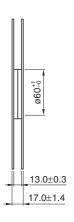
#### **TEST CIRCUIT**



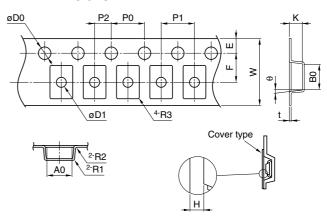
### **PACKAGING STYLES REEL DIMENSIONS**



• The taping reel dimensions and reusable reel are compliant with EIAJ ET-7200.



Dimensions in mm



				Dimensions in mm
A0	В0	W	F	E
4.45typ.	5.45typ.	12.00±0.2	5.50±0.1	1.75±0.1
				_
P1	P2	Н	P0	øD0
8.00±0.1	2.00±0.05	0.05 to 0.35	4.0±0.1	1.5+0.1/-0
K	øD1	t	R1 to R3	θ
1.35±0.1	1.2±0.2	0.25±0.05	0.3max.	5° typ.

# Inductors for Power Circuits Wound/STD • Magnetic Shielded

#### **Conformity to RoHS Directive**

### VLF Series VLF504015MT

With the VLF504015MT Series, a DC to DC converter with topclass voltage conversion efficiency for similar size products was achieved by optimizing the magnetic material and configuration. These products are optimal for use as choke coils in switching power supplies such as those in mobile devices requiring spacesaving design.

#### **FEATURES**

Miniature size

Mount area: 5.0×4.0mm

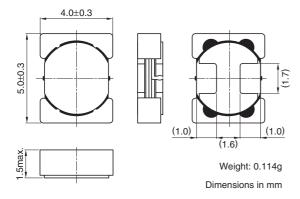
Low profile: 1.5mm max. height

- Generic use for portable DC to DC converter line.
- High magnetic shield construction should actualize high resolution for EMC protection.
- The products contain no lead and also support lead-free soldering.
- · The products is halogen-free.
- · It is a product conforming to RoHS directive.

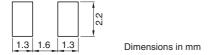
#### **APPLICATIONS**

Smartphones, cellular phones, DSCs, DVCs, HDDs, LCD displays, compact power supply modules, etc.

#### **SHAPES AND DIMENSIONS**



#### RECOMMENDED PC BOARD PATTERN



#### **CIRCUIT DIAGRAM**





#### PRODUCT IDENTIFICATION

VLF	504015M	Т -	1R0	Ν
(1)	(2)	(3)	(4)	(5)

- (1) Series name
- (2) Dimensions L×W×H mm max.

#### (3) Packaging style

T	Taping (Embossed carrier tape)				
(4) Inductance value					
1R0	1.0μΗ				
100	10μΗ				
(5) Inductance tolerance					
M	±20%				

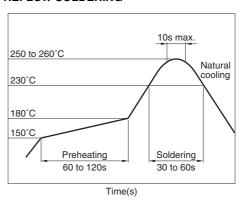
#### **PACKAGING STYLE AND QUANTITIES**

Packaging style	Quantity
Taping	1000 pieces/reel

±30%

#### HANDLING AND PRECAUTIONS

- Before soldering, be sure to preheat components.
   The preheating temperature should be set so that the temperature difference between the solder temperature and product temperature does not exceed 150°C.
- When hand soldering, apply the soldering iron to the printed circuit board only. Temperature of the iron tip should not exceed 350°C. Soldering time should not exceed 3 seconds.

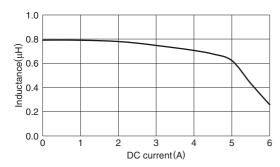


- Conformity to RoHS Directive: This means that, in conformity with EU Directive 2002/95/EC, lead, cadmium, mercury, hexavalent chromium, and specific bromine-based flame retardants, PBB and PBDE, have not been used, except for exempted applications.
- Please contact our Sales office when your application is considered the following:
   The device's failure or malfunction may directly endanger human life (e.g. application for automobile/aircraft/medical/nuclear power devices, etc.)

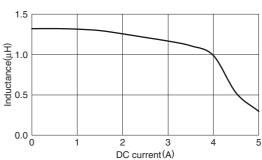
Part No.				DC resistance(	$stance(\Omega)$	Rated current*(A)		
		Inductance tolerance(%)	Test frequency (MHz)	max.	typ.	Based on inductance change Idc1		Based on temperature rise Idc2
						max.	typ.	typ.
VLF504015MT-1R0N	1.0	±30	1.0	0.032	0.026	3.72	4.14	3.61
VLF504015MT-1R5N	1.5	±30	1.0	0.038	0.032	3.42	3.80	3.27
VLF504015MT-2R2M	2.2	±20	1.0	0.053	0.044	2.71	3.01	2.60
VLF504015MT-3R3M	3.3	±20	1.0	0.063	0.053	2.33	2.59	2.51
VLF504015MT-4R7M	4.7	±20	1.0	0.07	0.06	1.98	2.20	2.43
VLF504015MT-6R8M	6.8	±20	1.0	0.10	0.08	1.65	1.83	2.00
VLF504015MT-100M	10.0	±20	1.0	0.14	0.12	1.30	1.44	1.58
VLF504015MT-150M	15.0	±20	1.0	0.22	0.18	1.13	1.25	1.37
VLF504015MT-220M	22.0	±20	1.0	0.31	0.26	0.93	1.03	1.08

<sup>\*</sup> Rated current: Value obtained when current flows and the temperature has risen to 40°C or when DC current flows and the nominal value of inductance has fallen by 30%, whichever is smaller.

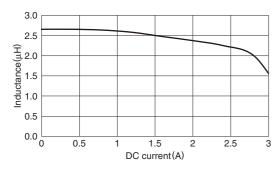
# TYPICAL ELECTRICAL CHARACTERISTICS INDUCTANCE vs. DC SUPERPOSITION CHARACTERISTICS VLF504015MT-1R0N



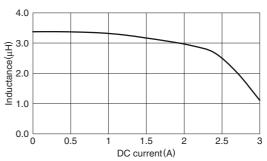
### VLF504015MT-1R5N



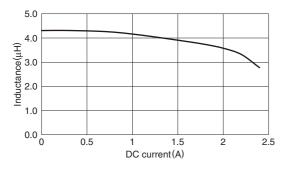
### VLF504015MT-2R2M



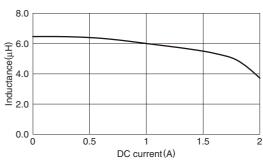
#### VLF504015MT-3R3M



#### VLF504015MT-4R7M



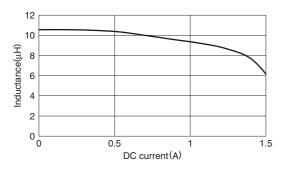
#### VLF504015MT-6R8M



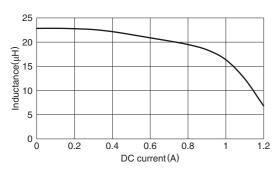
<sup>•</sup> Operating temperature range: -40 to +105°C (Including self-temperature rise)

<sup>•</sup> All specifications are subject to change without notice.

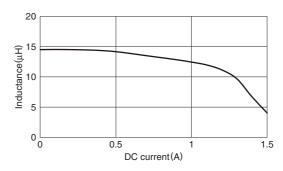
# TYPICAL ELECTRICAL CHARACTERISTICS INDUCTANCE vs. DC SUPERPOSITION CHARACTERISTICS VLF504015MT-100M



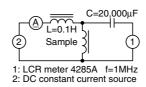
#### VLF504015MT-220M



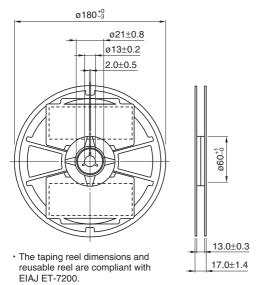
#### VLF504015MT-150M



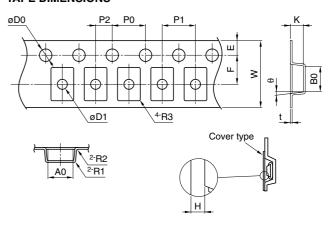
#### **TEST CIRCUIT**



# PACKAGING STYLES REEL DIMENSIONS



Dimensions in mm



				Dimensions in mm
A0	B0	W	F	E
4.45typ.	5.45typ.	12.00±0.2	5.50±0.1	1.75±0.1
P1	P2	Н	P0	øD0
8.00±0.1	2.00±0.05	0.05 to 0.35	4.0±0.1	1.5+0.1/-0
K	øD1	t	R1 to R3	θ
1.65±0.1	1.2±0.2	0.25±0.05	0.3max.	5° typ.

# **Mouser Electronics**

**Authorized Distributor** 

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

### TDK:

\text{VLF4012AT-150MR63} \text{VLF4012AT-6R8MR96} \text{VLF4012AT-220MR51} \text{VLF4012AT-330MR39} \text{VLF4012AT-100MR79} \text{VLF4012AT-3R3M1R3} \text{VLF4012AT-1R5M1R6} \text{VLF4012AT-2R2M1R5} \text{VLF4012AT-470MR30} \text{VLF4012AT-470MR30} \text{VLF4012AT-470MR30} \text{VLF4012AT-470MR30} \text{VLF4012AT-470MR30} \text{VLF4012AT-470MR30} \text{VLF4012AT-470MR30} \text{VLF4012AT-470MR30} \text{VLF4012AT-470MR30} \text{VLF5010AT-330MR41-2} \text{VLF302510MT-100M} \text{VLF302510MT-1750M} \text{VLF302510MT-1750M} \text{VLF302510MT-1750M} \text{VLF302510MT-1750M} \text{VLF302510MT-4R7M} \text{VLF302512MT-1750M} \text{VLF302512MT-1750M} \text{VLF302512MT-1750M} \text{VLF302512MT-1750M} \text{VLF302512MT-4R7M} \text{VLF302512MT-6R8M} \text{VLF3014AT-100MR59} \text{VLF3014AT-220MR37} \text{VLF3014AT-2R2M1R2} \text{VLF3014AT-3R3M1R0} \text{VLF3014AT-4R7MR90} \text{VLF3014AT-6R8MR72} \text{VLF4014AT-100MR90} \text{VLF4014AT-4R7M1R1} \text{VLF5012AT-100MR80} \text{VLF5012AT-2R2M1R5} \text{VLF5012AT-3R3M1R3} \text{VLF5012AT-4R7M1R1} \text{VLF302515MT-220M} \text{VLF302515MT-1750M} \text{VLF302515MT-150M} \text{VLF302515MT-185N} \text{VLF302515MT-185N} \text{VLF302515MT-R47N} \text{VLF302515MT-6R8M} \text{VLF302515MT-1R5N} \text{VLF302515MT-185N} \text{VLF302515MT-185N} \text{VLF302515MT-180M} \text{VLF302515MT-185N} \text{VLF302515MT-180M} \text{VLF302515MT-185N} \text{VLF302515MT-180M} \text{VLF302515MT-185N} \text{VLF302515MT-180M} \text{VLF302515MT-185N} \text{VLF302515MT-180M} \text{VLF302515MT-185N} \text{VLF302515MT-180M} \text{VLF302515MT-180M} \text{VLF302515MT-180M} \text{VLF302515MT-185N} \text{VLF302515MT-180M} \text{VLF302515MT-185N} \text{VLF302515MT-180M} \text{VLF3025